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Atty. Docket No. CPAC 1017-2
Appl. No. 10/632,549

NOV 29 2005

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Marcos KARNEZOS

) Examiner: Phat X. CAO

Application No.: 10/632,549

) Group Art Unit: 2814

Filed: August 2, 2003

) Date: 29 November, 2005.

Title: Semiconductor multi-package module
having wire bond interconnect between
stacked packages

) CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this correspondence is being facsimile transmitted to Mail Stop RCE in the United States Patent and Trademark Office, at the Central Fax no. 571-272-8300 on 29 November 2005.

Signed


Bill Kennedy

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AMENDMENT
ACCOMPANYING REQUEST FOR CONTINUED EXAMINATION

Dear Sir:

Applicant responds as follows to the Final Office action mailed June 29, 2005.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the claims are reflected in the **Listing of Claims** which begins on page 3 of this paper.

Remarks begin on page 6 of this paper.